

Preliminary Technical Information

High Voltage Power MOSFET

IXTF02N450

 $V_{DSS} = 4500V$ $I_{DSS} = 200mA$

 $R_{DS(on)} \leq 625\Omega$

(Electrically Isolated Tab)

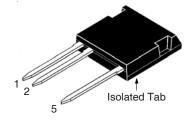


N-Channel Enhancement Mode

Symbol	Test Conditions	Maximum Ratings			
V _{DSS}	$T_{J} = 25^{\circ}C$ to $150^{\circ}C$	4500	V		
V _{DGR}	$T_J = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}, R_{GS} = 1\text{M}\Omega$	4500	V		
V _{GSS}	Continuous	±20	V		
V _{GSM}	Transient	±30	V		
I _{D25}	T _c = 25°C	200	mA		
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	600	mA		
P _D	$T_{c} = 25^{\circ}C$	78	W		
T _J		- 55 +150	°C		
T _{JM}		150	°C		
T _{stg}		- 55 +150	°C		
T,	Maximum Lead Temperature for Soldering	300	°C		
T _{SOLD}	Plastic Body for 10s	260	°C		
F_c	Mounting Force	20120 / 4.527	N/lb.		
V _{ISOL}	50/60Hz, 1 Minute	4500	V~		
Weight		6	g		

SymbolTest ConditionsChara $(T_J = 25^{\circ}C, Unless Otherwise Specified)$ Min.		cteristic Typ.	Value: Max.	s 	
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	4.0		6.5	V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nΑ
I _{DSS}	$V_{DS} = 3.6kV, V_{GS} = 0V$			5	μΑ
	$V_{DS} = 4.5kV$			10	μΑ
	$V_{DS} = 3.6kV$ Note 2, $T_{J} = 1.00$	= 125°C	15		μΑ
R _{DS(on)}	$V_{GS} = 10V, I_D = 10mA, Note 1$			625	Ω

ISOPLUS i4-Pak™



1 = Gate 5 = Drain 2 = Source

Features

- Silicon Chip on Direct-Copper Bond (DCB) Substrate
- Isolated Mounting Surface
- 4500V~ Electrical Isolation
- Molding Epoxies meet UL 94 V-0 Flammability Classification

Advantages

- High Voltage Package
- Easy to Mount
- Space Savings
- High Power Density

Applications

- High Voltage Power Supplies
- Capacitor Discharge Applications
- Pulse Circuits
- Laser and X-Ray Generation Systems



Symbol (T _J = 25°C, U	Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max.
g _{fs}	V _{DS} = 50V, I _D = 50mA, Note 1	90	150	mS
C _{iss}			246	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		19	pF
C _{rss}			5.8	pF
R_{Gi}	Gate Input Resistance		76	Ω
t _{d(on)}	Resistive Switching Times		17	ns
t _r	$V_{GS} = 10V, V_{DS} = 500V, I_{D} = 0.5 \bullet I_{D25}$		48	ns
t _{d(off)}	00 50 5 520		28	ns
t,	$R_{\rm G} = 10\Omega \text{ (External)}$		143	ns
$Q_{g(on)}$			10.6	nC
Q _{gs}	$V_{GS} = 10V, V_{DS} = 1kV, I_{D} = 0.5 \bullet I_{D25}$		3.3	nC
\mathbf{Q}_{gd}			5.5	nC
R _{thJC}				1.6 °C/W

MYZ	INCH	1ES	MILLIMETER	
2114	MIN	MAX	MIN	MAX
Α	.190	.205	4.83	5.21
A1	.102	.118	2.59	3.00
A2	.046	.085	1.17	2.16
b	.045	.055	1.14	1.40
b1	.058	.068	1.47	1.73
С	.020	.029	0.51	0.74
D	.819	.840	20.80	21.34
Ε	.770	.799	19.56	20.29
е	.150 BSC		3.81 BSC	
e1	.450BSC 11.43 BSC		BSC	
L	.780	.840	19,81	21.34
L1	.083	.102	2.11	2.59
Q	.210	.244	5.33	6.20
R	.100	.180	2.54	4.57
S	.660	.690	16.76	17.53
Т	.590	.620	14.99	15.75
U	.065	.080	1.65	2.03

Source-Drain Diode

SymbolTest ConditionsCha $(T_J = 25^{\circ}C, Unless Otherwise Specified)$ Min		 cteristic Typ.	teristic Values Typ. Max.		
I _s	$V_{gS} = 0V$		200	mA	
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{JM}}$		800	mA	
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1		1.5	V	
t _{rr}	$I_F = 200 \text{mA}, -\text{di/dt} = 50 \text{A/} \mu \text{s}, V_R = 100 \text{V}$	1.6		μs	

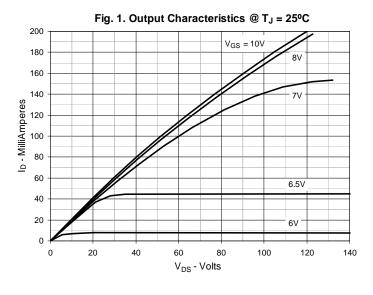
Notes: 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

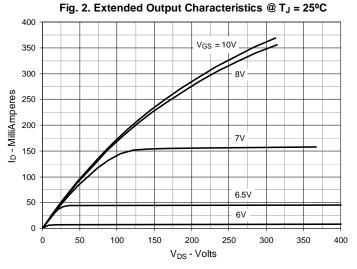
2. Part must be heatsunk for high-temp $\mathbf{I}_{\mathrm{DSS}}$ measurement.

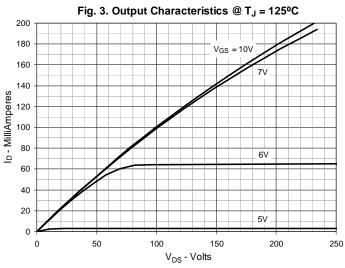
PRELIMANARY TECHNICAL INFORMATION

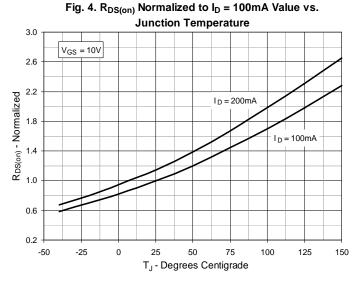
The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

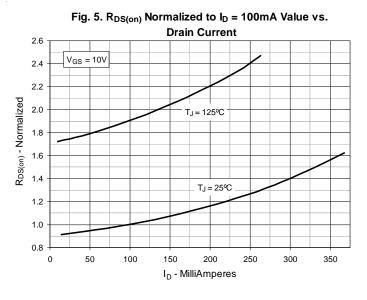


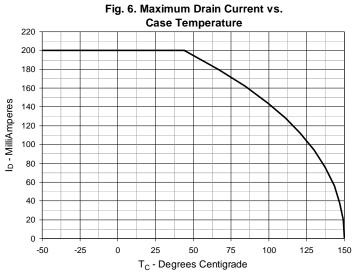




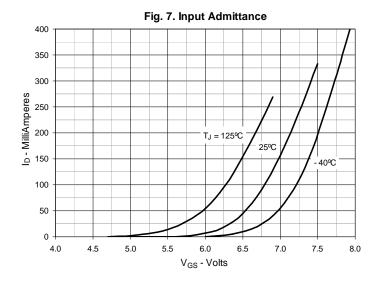


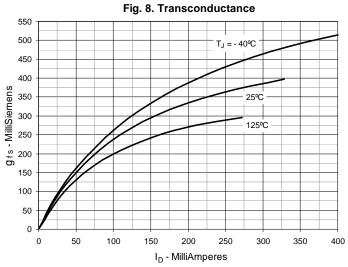


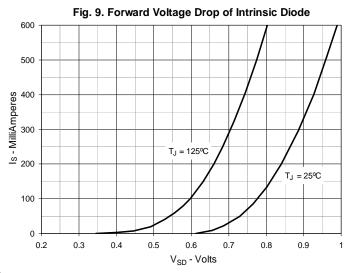


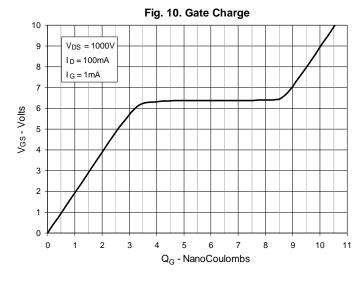


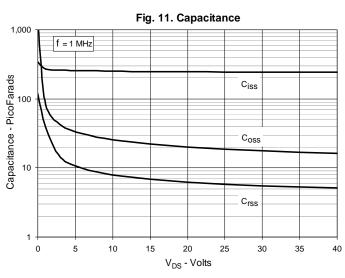


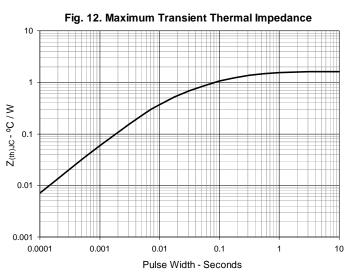












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Fig. 13. Forward-Bias Safe Operating Area

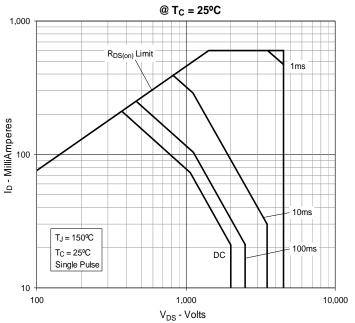
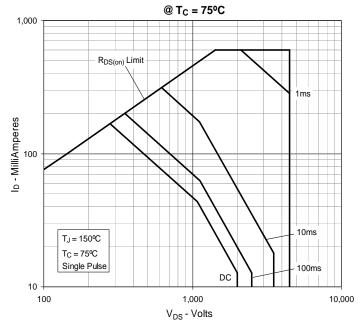


Fig. 14. Forward-Bias Safe Operating Area



Mouser Electronics

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IXYS: IXTF02N450